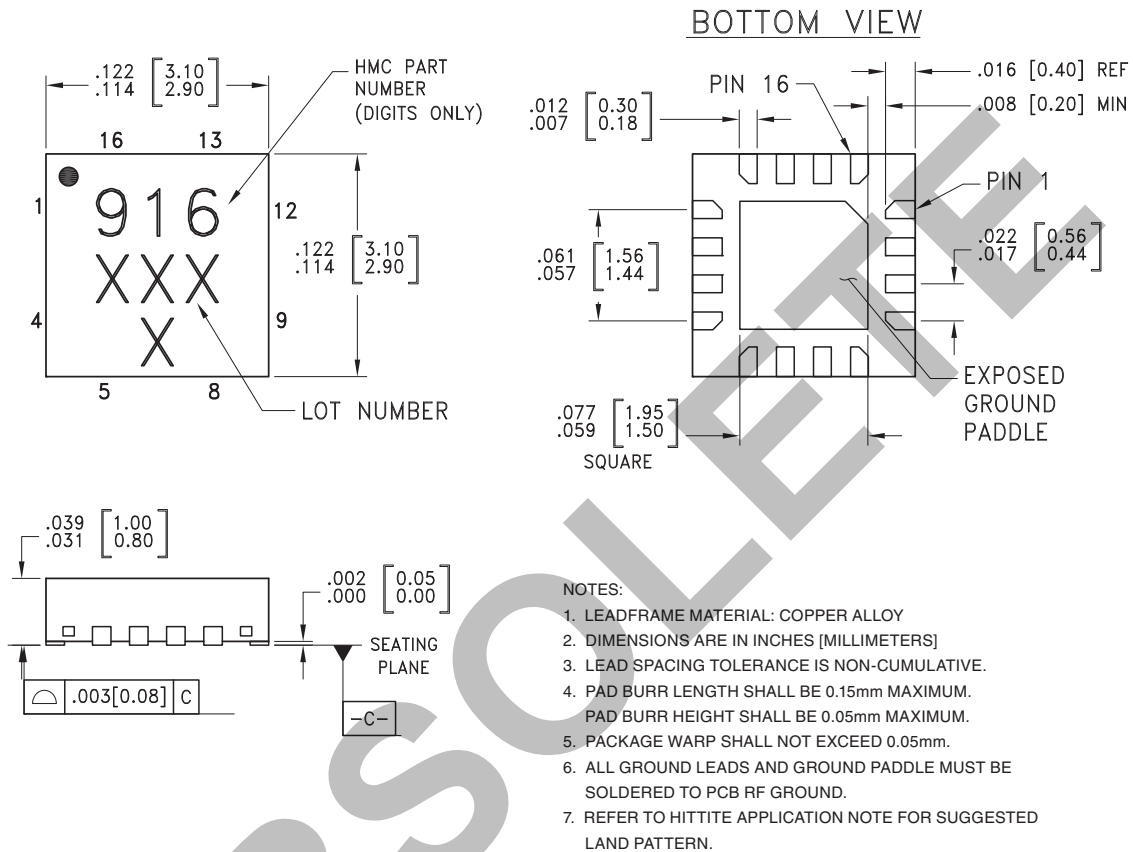




SMT MMIC x3 ACTIVE FREQUENCY MULTIPLIER, 8 - 16 GHz OUTPUT

Outline Drawing



Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[1]
HMC916LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	916 XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C



SMT MMIC x3 ACTIVE FREQUENCY MULTIPLIER, 8 - 16 GHz OUTPUT

Pin Description

Pin Number	Function	Description	Interface Schematic
1, 4 - 9, 12, 13, 15, 16	GND	These pins and exposed paddle must be connected to RF/DC ground.	
2	RFNIN (or GND)	This pin is AC coupled and matched to 50 ohms, and is 180° out of phase with pin 3 for differential operation. RF/DC ground for single ended operation.	
3	RFIN	This pin is AC coupled and matched to 50 ohms	
10	RFOUT	This pin is AC coupled and matched to 50 ohms	
11	RFNOUT	This pin is AC coupled and matched to 50 ohms, and is 180° out of phase with pin 10 for differential operation. Terminate in 50 ohms for single ended operation.	
14	Vcc	Supply voltage +5V	

5

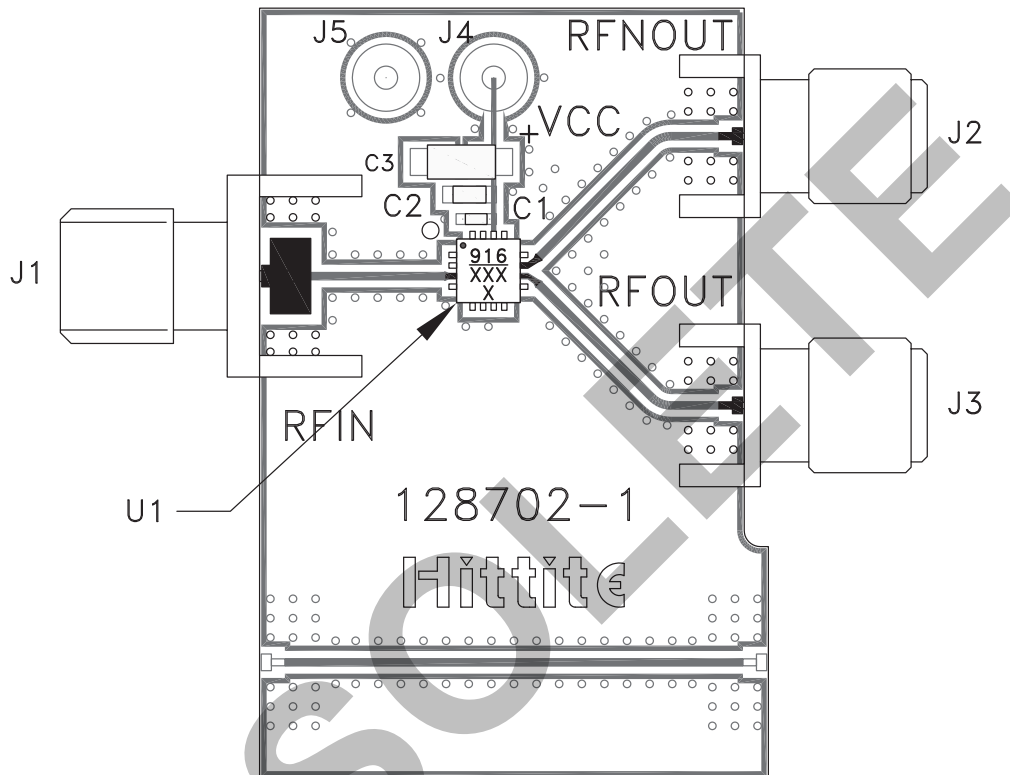
FREQ. MULTIPLIERS - ACTIVE - SMT

OBSOLETE



**SMT MMIC x3 ACTIVE
FREQUENCY MULTIPLIER, 8 - 16 GHz OUTPUT**

Evaluation PCB



List of Materials for Evaluation PCB 128383 [1]

Item	Description
J1 - J3	PCB Mount SMA Connector
J4, J5	DC Pin
C1	100 pF Capacitor, 0402 Pkg.
C2	1000 pF Capacitor, 0402 Pkg.
C3	4.7 μF Capacitor, 0402 Pkg.
U1	HMC916LP3E x3 Active Multiplier
PCB [2]	128702 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.